□ MN675048, MN675058

Туре	MN675048, MN675058				
ROM (×8-Bit)	64 K / 80 K				
RAM (×8-Bit)	1 024 / 1 280				
Minimum Instruction Execution Time	With Main Clock operated With Sub-Clock operated With Sub-Clock operated				
Interrupts	• RESET • Runaway • External 0, 1, 2 / Key Input (P50 to 54) • Input Capture 0, 1 • Timer 0 / Timer 0 / Timer 1 • Timer 2 • Timer 3 / Cylinder FG • Timer 4 / Synchronous Output / Continuous Synchronous Output • Serial 0 • Serial 1 / A/D Conversion / Remote Control Receive				
Timer Counter	Timer Counter 0 · 16-Bit × 1 (Timer Output, Output Compare) Clock Source 1/1, 1/2, of System Clock, 1/16, 1/32 of OSC Oscillation Clock, 1/512 of XI Oscillation Clock or OSC Oscillation Clock Overflow of Timer Counter 0, Coincidence of Output Compare Register 0 and Timer Counter 0				
	Timer Counter 1 : 16-Bit × 1 (Timer Output, Event Count [CTL Signal], Synchronous Serial Clock Generator) Clock Source Interrupt Source Overflow of Timer Counter 1				
	Timer Counter 2: 16-Bit × 1 (Timer Output, Input Capture, [DCTL Specified Edge], DCTL Signal Duty Judge) Clock Source Interrupt Source Overflow of Timer Counter 2, DCTL Specified Edge Input, Timer-2 Shift Register 4-Bit Counter Underflow, Coincidence of Timer-2 Shift Register and Timer-2 Shift Register compare-register				
	Timer Counter 3:16-Bit × 1 (Timer Output, Serial Index Search) Clock Source 1/1, 1/2 of System Clock, 1/16, 1/32 of OSC Oscillation Clock Interrupt Source Overflow of Timer Counter 3				
	Timer Counter 4 : 16-Bit × 1 (Timer Output, Event Count [P92 Input]) Clock Source 1/16, 1/32 of OSC Oscillation Clock, External Clock Input Interrupt Source Overflow of Timer Counter 4				
	Timer Counter 5 : 16-Bit × 1 (Timer Output, Watchdog) Clock Source Interrupt Source 1/2 ¹¹ , 1/2 ¹² , 1/2 ¹³ of Timer Counter 5, Overflow (PI)				
	Timer Counter 6 : 30-Bit × 1 (Timer Output, Clock function [Maximum 4 hours], Buzzer Output) Clock Source . 1/32, 1/64, 1/256,1/512 of OSC Oscillation Clock, XI Oscillation Clock, 1/2 of System Clock Interrupt Source 1 second Output, 1 minute Output, 1 hour Output, 4 hour Output				
	Timer Counter 7: 8-Bit × 1 (Simple Remote Control Reception) Clock Source 1/8, 1/16, 1/32, 1/64 of System Clock				

8th Overflow of Timer Counter 7

Interrupt Source

Serial Interface

Serial 0: 8-Bit × 1 (Synchronous Type) (Transfer direction of MSB/LSB selectable, Start Condition function,

FIFO • 8 or 16-Bit length Transmission/Reception[8bits by 8 stages])

Clock Source $\,$ 1/2, 1/4, 1/8, 1/16, 1/32, 1/64, 1/128, of System Clock, Timer 4 Output 2

dividing, SBTO Pin Input

 $\textbf{Serial 1: 8-Bit} \times \textbf{1} \text{ (Synchronous Type) (Transfer direction of MSB/LSB selectable, Start Condition function,} \\$

Simple I2C function)

Clock Source 1/2, 1/4, 1/8, 1/16, 1/32, 1/64, 1/128, of System Clock, Timer 4 Output 2

dividing, SBT1 pin Input

I/O Pins	1/0	60	• Common use 41 Port 0, 1, 4, 5, 6, 7, A, B, by -bit
	Input	14	• Common use 14
	Output	1	• Common use 1
A/D Input	S	-	8-Bit × 12ch (without S/H)
PWM			10-Bit × 2ch (at Repetition Cycle 143 μs, 14 32 MHz), 11-Bit × 2ch (at Repetition Cycle 286 μs, 14 32 MHz), 14-Bit × 1ch (at Repetition Cycle 2 288 μs, 14 32 MHz)
ICR			16-Bit × 5ch
OCR			16-Bit × 7ch, 8-Bit × 1ch
Special Ports			Buzzer Output, Tri-State Output (PTO) VLP Pin, Synchronous Output 7, Tri-State Synchronous Output 4 Remote Control Receive, CTL Amp, FG Amp built-in, 1/2 Output of OSC Oscillation Clock (2 V[p-p]), 1/4 Output of OSC Oscillation Clock (1 V[p-p]), Error Amp etc built-in

Electrical Characteristics

Notes

Package

Supply Current

QFP100-P-1818B

VISS/VASS Detector function

Parameter	Symbol	Centition	####	Limit Iyo	mex	Unit
Operating Supply Current	IDD1	At 14 32 MHz Operation, No load		30	60	mA
Operating Supply Current	IDD2	14 32 MHz Oscillation, SLOW Operation, No load		2	5	mΑ
Supply Current at STOP	IDSP	Oscillaiton halt, No load			20	μΑ
Supply Current at HALT	IDHT	14 32 MHz Oscillation, No load			5	mA

(Ta = 25 °C±2 °C, VDD = 5.0 V, VSS = 0 V)

A/D Converter Characteristics

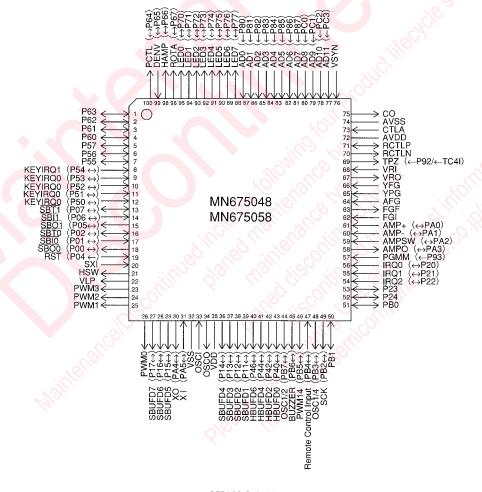
Parameter	Symbol	Condition	min	Limit	mex	Unit
Differential Nonlinearity	ΔNLAD				±3	LSB
A/D Conversion Time	tAD	fosc = 14 32 MHz		8		μs
Analog Input Voltage			0.5		4 5	٧

(Ta = 25 °C±2 °C, VDD = 5.0 V, VSS = 0 V)

Support Tool

In-Circuit Emulator	PX-ICE1880-2 + PX-PRB67508			
EPROM built-in Type	Туре	MN67P5068 [ES (Engineering Sample) available]		
	ROM (× 8-Bit)	96 K		
	RAM (× 8-Bit)	1 560		
	Minimum Instruction	0 279 μs (at 4 5 V to 5 5 V, 14 32 MHz)		
	Execution Time	122 μs (at 2 7 V to 5 5 V, 32 768 kHz)		
	Package	QFP100-P-1818B		
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Pin Assignment



QFP100-P-1818B

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